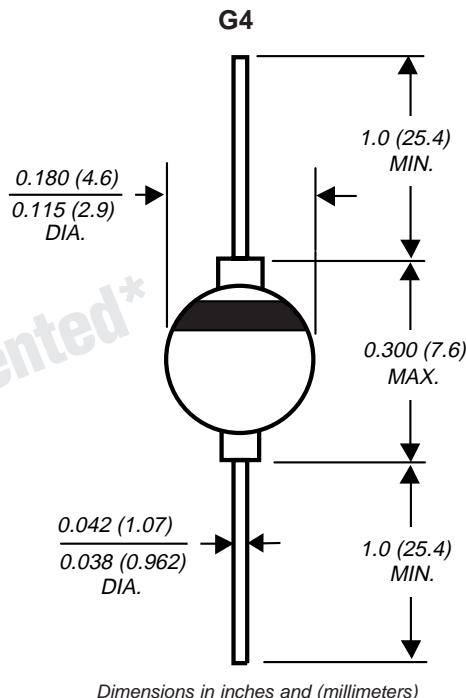


Glass Passivated Ultrafast Rectifier



*Brazed-lead assembly is covered by Patent No. 3,930,306

Reverse Voltage 50 to 200 V
 Forward Current 3.5 A

Features

- High temperature metallurgically bonded construction
- Cavity-free glass passivated junction
- Ultrafast recovery time for high efficiency
- Low forward voltage, high current capability
- Capable of meeting environmental standards of MIL-S-19500
- Hermetically sealed package
- Low leakage current
- High surge current capability
- High temperature soldering guaranteed: 350°C/10 seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension

Mechanical Data

Case: Solid glass body

Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any

Weight: 0.037 ounce, 1.04 grams

Maximum Ratings & Thermal Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	BYV28-50	BYV28-100	BYV28-150	BYV28-200	Units
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	V
Maximum DC blocking voltage	V _{DC}	50	100	150	200	V
Minimum reverse breakdown voltage at 100 µA	V _{BR}	55	110	165	220	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at T _L =85°C	I _{F(AV)}	3.5				A
Peak forward surge current 10ms single half sine-wave superimposed on rated load at T _J =175°C	I _{FSM}	90				A
Typical thermal resistance ^(1, 2)	R _{θJA} R _{θJL}	55 20				°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175				°C

Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Maximum instantaneous forward voltage at 3.5A	T _J =25°C T _J =175°C	V _F	1.1 0.89		V
Maximum DC reverse current at rated DC blocking voltage	T _A =25°C T _A =165°C	I _R	1.0 150		µA
Maximum reverse recovery time at I _F =0.5A, I _R =1.0A, I _{rr} =0.25A		t _{rr}	30		ns
Typical junction capacitance at 4.0V, 1MHz		C _J	100		pF

Notes:

- (1) Thermal resistance from junction to lead at 0.375" (9.5mm) lead length with both leads attached to heatsink
- (2) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, and mounted on P.C.B.

BYV28-50 thru BYV28-200



Vishay Semiconductors
formerly General Semiconductor

Ratings and Characteristic Curves (TA = 25°C unless otherwise noted)

Fig. 1 — Maximum Forward Current Derating Curves

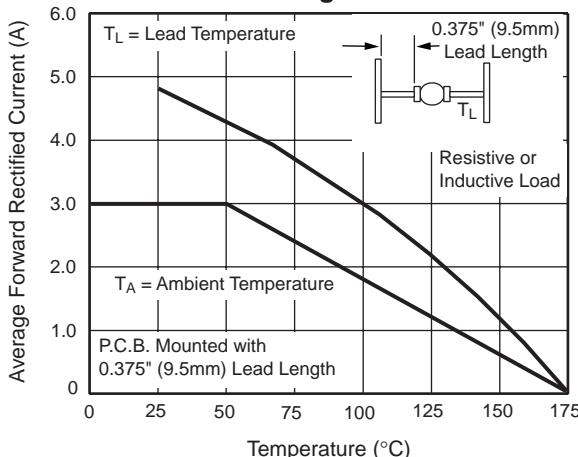


Fig. 2 — Maximum Non-Repetitive Peak Forward Surge Current

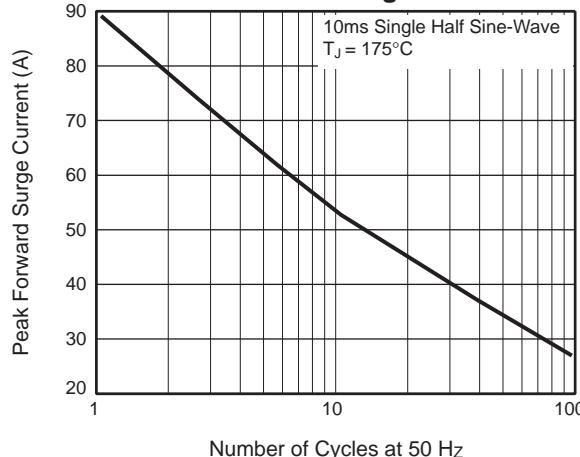


Fig. 3 — Typical Instantaneous Forward Characteristics

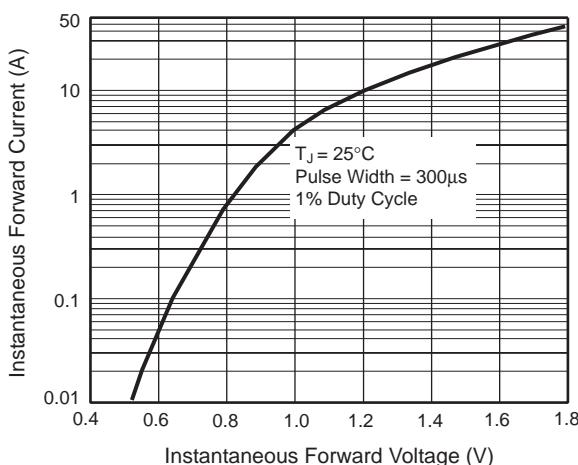


Fig. 4 — Typical Reverse Leakage Characteristics

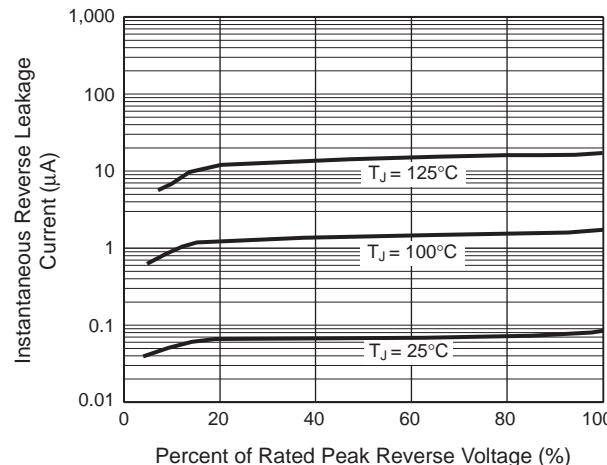


Fig. 5 — Typical Junction Capacitance

